## Ultra small, Low NF, Single Band LNA-IC for 600 MHz Band Applications

#### **FEATURES**

• Low voltage operation +2.85 V typ.

• Low current consumption

3 mA typ. (High-Gain mode)

1 μA typ. (Low-Gain mode)

• High gain 15.0 dB typ. fRX = 620 MHz (High-Gain mode)

• Low noise figure

1.20 dB typ. fRX = 620 MHz (High-Gain mode)

• Low distortion (IIP3 +10 MHz offset)

-4.0 dBm typ. fRX = 620 MHz (High-Gain mode)

• 5 pin Wafer level chip size package (WLCSP)

#### **DESCRIPTION**

AN26027A is single band LNA-IC for 600 MHz Band applications.

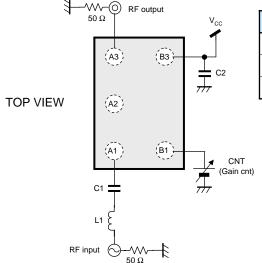
It realizes high performance by using 0.18  $\mu$ m SiGeC Bi-CMOS process (f<sub>T</sub> = 90 GHz, f<sub>max</sub> = 140 GHz). High/Low Gain-mode is changeable, controlled by integrated CMOS logic circuit.

A WLCSP package (Wafer Level Chip Sized Package) achieves miniaturization.

#### **APPLICATIONS**

●DTV (UHF)

#### SIMPLIFIED APPLICATION



Components	Size	Value	Part Number	Vendor
L1	0603	8.2 nH	LQP03TN8N2H04	Murata
C1	0603	1 000 pF	GRM033B11C102KD01	Murata
C2	0603	100 000 pF	GRM33B30J104KE18	Murata

Notes) This application circuit is an example. The operation of mass production set is not guaranteed. You should perform enough evaluation and verification on the design of mass production set. You are fully responsible for the incorporation of the above application circuit and information in the design of your equipment.



#### **ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Rating	Unit	Note
Supply voltage	V <sub>cc</sub>	3.6	V	*1
Supply current	I <sub>cc</sub>	18	mA	_
Operating ambient temperature	T <sub>opr</sub>	–25 to 75	°C	*2
Operating junction temperature	T <sub>j</sub>	-40 to +125	°C	*2
Storage temperature	T <sub>stg</sub>	-40 to +125	°C	*2
	IN (Pin No.A1)	_	V	*3
Input Voltage Range	CNT (Pin No.B1)	-0.3 to V <sub>CC</sub>	V	_
	OUT (Pin No.A3)	_	V	*4
FOD	HBM (Human Body Model)	1	kV	_
ESD	MM (Machine Model)	100	V	_

Notes). This product may sustain permanent damage if subjected to conditions higher than the above stated absolute maximum rating.

This rating is the maximum rating and device operating at this range is not guaranteeable as it is higher than our stated recommended operating range.

When subjected under the absolute maximum rating for a long time, the reliability of the product may be affected.

#### POWER DISSIPATION RATING

PACKAGE	θ <sub>JA</sub>	PD (Ta=75 °C)	
WLCSP	1391.0°C/W	0.072W	0.036W

Note). For the actual usage, please refer to the PD-Ta characteristics diagram in the package specification, supply voltage, load and ambient temperature conditions to ensure that there is enough margin follow the power and the thermal design does not exceed the allowable value.



#### **CAUTION**

Although this has limited built-in ESD protection circuit, but permanent damage may occur on it. Therefore, proper ESD precautions are recommended to avoid electrostatic damage to the MOS gates

#### RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min.	Тур. Мах.		Unit	Note
Supply voltage range	$V_{cc}$	2.5	2.85	3.0	V	*1

Note) \*1 : The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

<sup>\*1:</sup>The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

<sup>\*2:</sup>Except for the operating ambient temperature, operating junction temperature, and storage temperature, all ratings are for Ta = 25°C.

<sup>\*3:</sup>RF signal input pin. Do not apply DC.

<sup>\*4:</sup>RF signal output pin. Do not apply DC.



#### **ELECRTRICAL CHARACTERISTICS**

Note) Vcc = 2.85 V,  $Ta = 25^{\circ}C \pm 2^{\circ}C$ , unless otherwise specified.

	Parameter	Symbol	Condition	Limits			Unit	Noto
	rarameter		Condition	Min	Тур	Max	Unit	Note
DC	electrical characteristics							
	Supply current HG	IccH	Vcc current at High-Gain mode No input signal	_	3.0	4.4	mA	_
	Supply current LG	IccL	Vcc current at Low-Gain mode No input signal	_	1.0	10	μΑ	_
	Switching voltage (High Gain Mode)	VIH	VIH = Vcc × 0.90	2.57	2.85	_	V	_
	Switching voltage (Low Gain Mode)	VIL	VIL = Vcc × 0.14	_	0.0	0.4	V	_
	Switching current(High)	IIH	Current at CNT pin VIH = Vcc	_	4.6	20	μΑ	_



#### **ELECRTRICAL CHARACTERISTICS (continued)**

Note) Vcc = 2.85 V,  $Ta=25^{\circ}C\pm2^{\circ}C$ , fRXa=620 MHz, PRX=-30 dBm, CW unless otherwise specified.

	Parameter	Symbol	Condition	Limits			Unit	Note
	Faranietei	Syllibol	Symbol Condition		Тур	Max	Onit	Note
LN	A AC electrical characteristic	s						
	Power Gain HG	GHS	High-Gain mode	13.0	15.0	17.0	dB	_
	Power Gain LG	GLS	Low-Gain mode PRX = -20 dBm	-7.5	-4.0	-1.0	dB	_
	IIP3 +10 MHz offset HG	IIP3H1	High-Gain mode f1 = fRXa + 10 MHz f2 = fRXa + 20 MHz Input 2 signals (f1, f2)	-12	-4.0	_	dBm	_



## APPLICATION INFORMATION REFERENCE VALUES FOR DESIGN

Notes) Vcc = 2.85 V

 $Ta = 25^{\circ}C \pm 2^{\circ}C$ , fRXb = 470 MHz, 620 MHz, 770 MHz, PRX = -30 dBm, CW unless otherwise specified.

B	0	O and dition a	Refer	ence v	alues	11!1	Note
Parameter	Symbol Conditions		Min	Тур Мах		Unit	Note
LNA AC electrical characteristics							
Power Gain HG	GH	High-Gain mode	11.5	15.0	17.5	dB	*1
Power GainLG	GL	Low-Gain mode PRX = -20 dBm	-8.0	-4.0	-1.0	dB	*1
Noise Figure HG	NFH	High-Gain mode	_	1.3	2.3	dB	*1,*3
Noise Figure LG	NFL	Low-Gain mode	_	6.5	8.5	dB	*1
IIP3 +10 MHz offset HG	IIP3H1	High-Gain mode f1 = fRXb + 10 MHz f2 = fRXb + 20 MHz Input 2 signals (f1, f2)	-13	-4.0	_	dBm	*1
IIP3 +10 MHz offset HG	IIP3 +10 MHz offset HG IIP3H2		-13	-4.0	_	dBm	*1
Input P1dB HG	IP1dBH	High-Gain mode	-10	-6	_	dBm	*1
Reverse Isolation HG	ISOH	High-Gain mode	_	-24	_	dB	*2
Reverse Isolation LG	ISOL	High-Gain mode	_	-3.5	_	dB	*2

Note)

\*1 : Checked by design, not production tested.

\*2 : Typical Value checked by design.

\*3 : Connector & substrate loss (0.10 dB) included.



## APPLICATION INFORMATION (continued) REFERENCE VALUES FOR DESIGN (continued)

Notes) Vcc = 2.5 V to 3.0 V

Ta = -25°C to 75°C unless otherwise specified.

	Davamatar	Comple ed	Symbol Conditions		ence v	Unit	Nata	
	Parameter	Symbol Conditions		Min	Тур	Max	Unit	Note
DC e	electrical characteristics							
	Supply current HG	IccHT	VCC current at High-Gain mode No input signal	_	3.0	4.5	mA	*1
	Supply current LG	IccLT	VCC current at Low-Gain mode No input signal	_	1.0	10.0	μΑ	*1
	Switching current (High)	IIHT	Current at CNT pin VIH = V <sub>CC</sub>	_	4.6	20	μΑ	*1

Note) \*1 : Checked by design, not production tested.



## APPLICATION INFORMATION (continued) REFERENCE VALUES FOR DESIGN (continued)

Notes) Vcc = 2.5 V to 3.0 V

Ta = -25°C to 75°C, fRXb = 470 MHz, 620 MHz, 770 MHz, PRX = -30 dBm, CW unless otherwise specified

	Parameter	Cumbal	Conditions	Refer	ence v	alues	Unit	Note
	Parameter	Symbol	Conditions	Min	Тур	Max	Unit	Note
LNA	A AC electrical characteristics							
	Power Gain HG	GHT	High-Gain mode	11.0	15.0	18.0	dB	*1
	Power Gain LG	GLT	Low-Gain mode PRX = -20 dBm	-8.5	-4.0	-1.0	dB	*1
	Noise Figure HG	NFHT	High-Gain mode	_	1.3	3.0	dB	*1,*3
	Noise Figure LG	NFLT	Low-Gain mode	_	6.5	9.0	dB	*1
	IIP3 +10 MHz offset HG	IIP3H1Ta	High-Gain mode f1 = fRXb + 10 MHz f2 = fRXb + 20 MHz Input 2 signals (f1, f2)	-14.0	-4.0	_	dBm	*1
	IIP3 +10 MHz offset HG	IIP3H2Ta	High-Gain mode f1 = fRXb - 10 MHz f2 = fRXb - 20 MHz Input 2 signals (f1, f2)	-14.0	-4.0	_	dBm	*1
	Input P1dB HG	P1dBHT	High-Gain mode f1 = fRXb - 190 MHz PRX1 = -27 dBm f2 = fRXb - 95 MHz PRX2 = -33 dBm Input 2 signals (f1, f2)	-12.0	-6.0	_	dBm	*1

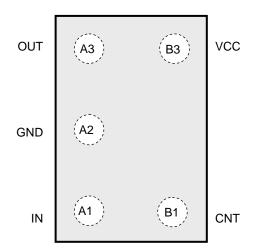
Note) \*1 : Checked by design, not production tested.

\*3 : Connector & substrate loss (0.10 dB) included.



#### **PIN CONFIGURATION**

Top View

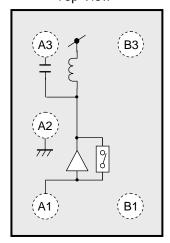


#### **PIN FUNCTIONS**

Pin No.	Pin name	Туре	Description			
A1	IN	Input	RF Input			
A2	GND	Ground	GND			
А3	OUT	Output	RF Output			
B1	CNT	Input	High-Gain / Low-Gain switch L: Low-Gain Mode H: High-Gain Mode			
В3	VCC	Power Supply	V <sub>cc</sub>			

#### **FUNCTIONAL BLOCK DIAGRAM**

Top View



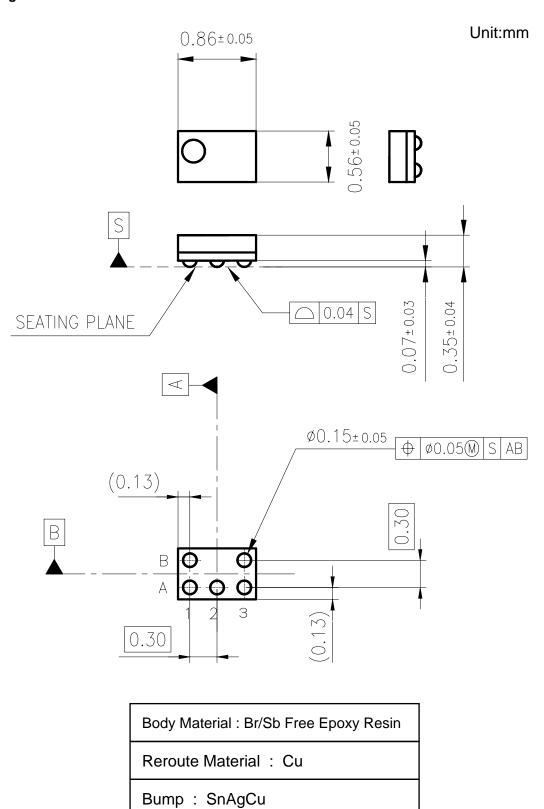
Notes) This circuit and these circuit constants show an example and do not guarantee the design as a mass-production set.

This block diagram is for explaining functions. The part of the block diagram may be omitted, or it may be simplified.



#### PACKAGE INFORMATION (Reference Data)

#### Package Code: ALGA005-W-0609ANA





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